

650V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information			
Device Package		Marking	
CS8N65F	TO-220F	CS8N65F	
CS8N65P	TO-220	CS8N65P	

TO-220F GDS	TO-220 GDS

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted				
Parameter	Symbol	Va	Unit	
		TO-220F	TO-220	Unit
Drain-Source Voltage ($V_{GS} = 0V$)	V _{DSS}	650		V
Continuous Drain Current	I _D	8		А
Pulsed Drain Current (note1)	I _{DM}	32		А
Gate-Source Voltage	V _{GSS}	±	30	V
Single Pulse Avalanche Energy (note2)	E _{AS}	245		mJ
Avalanche Current (note1)	I _{AS}	7		А
Repetitive Avalanche Energy (note1)	E _{AR}	147		mJ
Power Dissipation ($T_c = 25^{\circ}C$)	P _D	64	107	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150		°C

Thermal Resistance				
Peremeter	Symbol	Val	Unit	
Parameter		TO-220F	TO-220	- Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	1.95	1.17	K/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60	rv VV





Specifications $T_J = 25^{\circ}C$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
		Test conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_{D} = 250 \mu A$	650			V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μA
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 30V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_D = 4A$		0.95	1.15	Ω
Dynamic						
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$ f = 1.0MHz		1110		pF
Output Capacitance	C _{oss}			106		
Reverse Transfer Capacitance	C _{rss}			13		
Total Gate Charge	Q _g	$V_{DD} = 520V, I_D = 8A,$ $V_{GS} = 10V$		37		
Gate-Source Charge	Q _{gs}			5		nC
Gate-Drain Charge	Q_{gd}			24		
Turn-on Delay Time	t _{d(on)}			39		
Turn-on Rise Time	t _r	V _{DD} = 325V, I _D =8A,		10		
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 25 \ \Omega$		152		ns
Turn-off Fall Time	t _f			42		
Drain-Source Body Diode Character	istics					
Continuous Body Diode Current	۱ _s	T _C = 25 °C			8	
Pulsed Diode Forward Current	I _{SM}				32	A
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C, I_{SD} = 4A, V_{GS} = 0V$			1.4	V
Reverse Recovery Time	t _{rr}	V _{GS} = 0V,I _S = 8A, di _F /dt =100A /µs		601		ns
Reverse Recovery Charge	Q _{rr}			2.3		μC

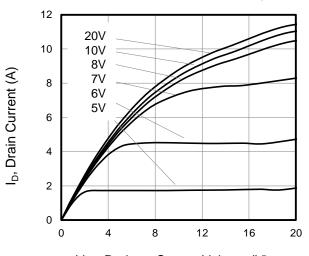
Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 °C
- 3. Pulse Test: Pulse width \leq 325µs, Duty Cycle \leq 1%

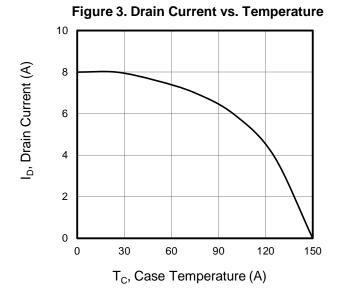


Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

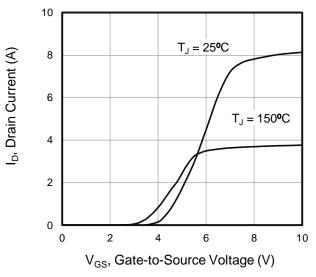
Figure 1. Output Characteristics (T_J = 25°C)

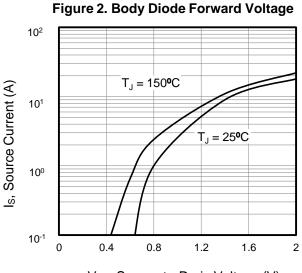


 $V_{\text{DS}},$ Drain-to-Source Voltage (V)









 $V_{\text{SD}},$ Source-to-Drain Voltage (V)



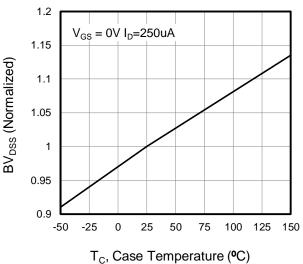
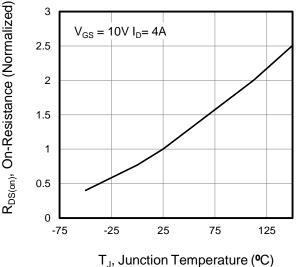
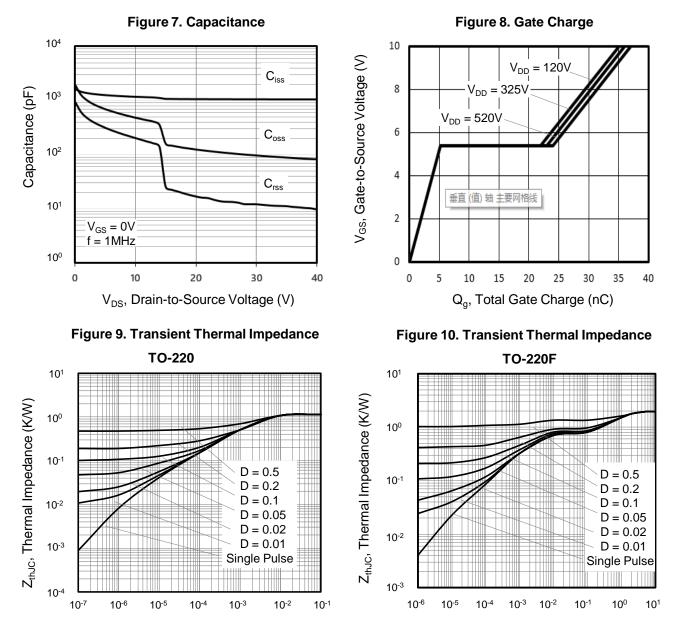


Figure 6. On-Resistance vs. Temperature





Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted



T_p, Pulse Width (s)

T_p, Pulse Width (s)





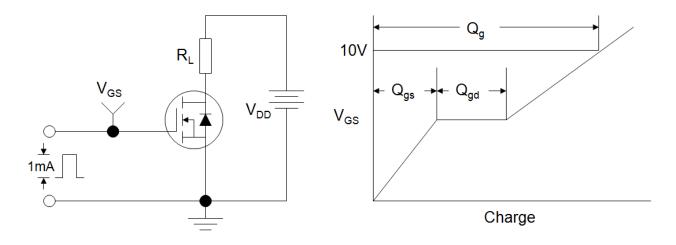


Figure B: Resistive Switching Test Circuit and Waveform

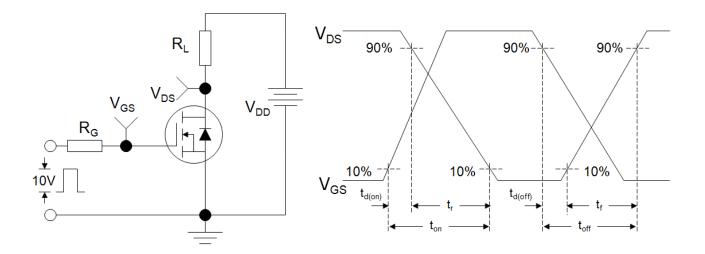
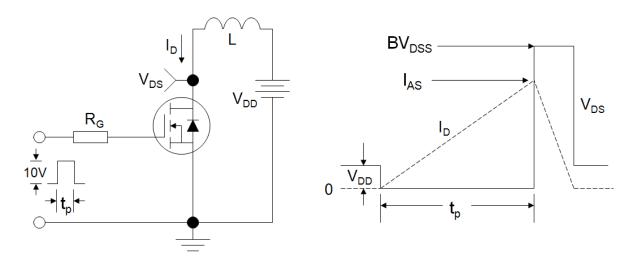


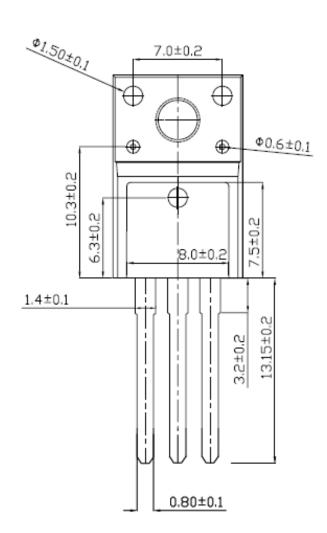
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

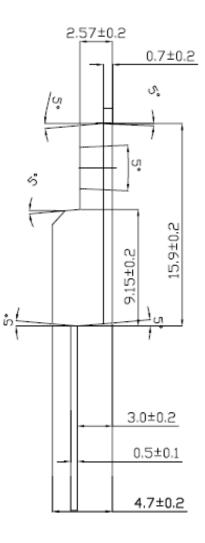






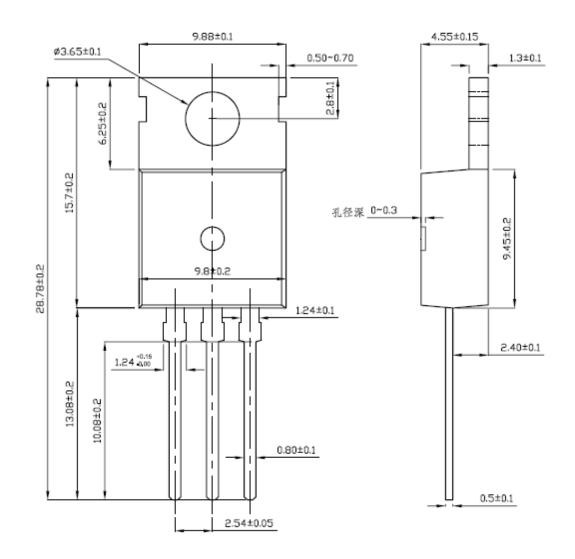
TO-220F







TO-220





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